Block Diagram

Zero-Voltage Switch with Adjustable Ramp

Description

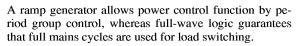
TEMIC

conductor:

The integrated circuit, U217B, is designed as a zero-voltage switch in bipolar technology. It is used to control resistive loads at mains by a triac in zero-crossing mode.

Features

- Direct supply from the mains
- Current consumption ≤ 0.5 mA
- Very few external components
- Full-wave drive no DC current component in the load circuit
- Negative output current pulse typ. 100 mA short-circuit protected



- Simple power control
- Ramp generator
- Reference voltage

Applications

- Full-wave power control
- Temperature regulation
- Power blinking switch

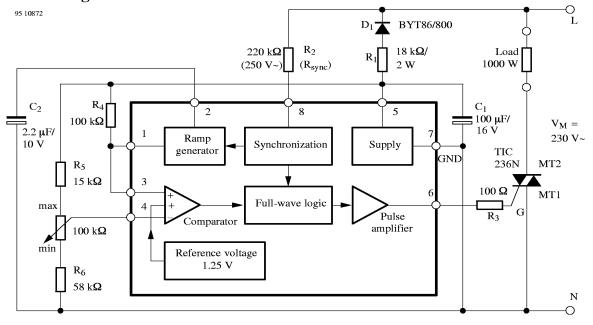


Figure 1. Block diagram with typical circuit, period group control 0 to 100%

Order Information

Extended Type Number	Package	Remarks
U217B-B	DIP8	
U217B-BFP	SO8	
U217B-BFPG3	SO8	Taped and reeled

U217B

Pin Description 1 8 V_{sync} Rampe 7 2 GND C_{Ramp} OP+ 3 6 Output OP-5 Vs 4 14841

Figure 2. Pinning

Pin	Symbol	Function
1	Rampe	Ramp output
2	C _{RAmp}	Ramp capacitor
3	OP+	OP non-inverting input
4	OP-	OP inverting input
5	Vs	Supply voltage
6	Output	Trigger pulse output
7	GND	Ground
8	V _{sync}	Voltage synchronization

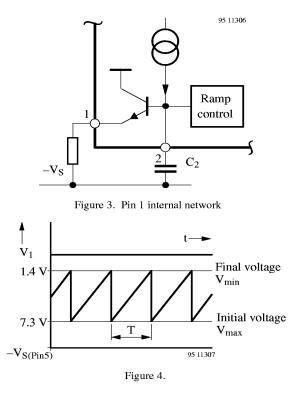
General Description

The integrated circuit, U217B, is a triac controller for zero-crossing mode. It is meant to control power in switching resistive loads of mains supply.

Information regarding supply sync. is provided at Pin 8 via resistor R_{Svnc} .

To avoid DC load on the mains, the full-wave logic guarantees that complete mains cycles are used for load switching.

A fire pulse is released when the inverted input of the comparator is negative (Pin 4) with respect to the non-inverted input (Pin 3) and internal reference voltage. A ramp generator with free selectable duration is possible with capacitor C₂ at Pin 2 which provides not only symmetrical pulse burst control (figure 3), but also control with superimposed proportional band (figure 10). Ramp voltage available at capacitor C2 is decoupled across emitter follower at Pin 1. To maintain the lamp flicker specification, ramp duration is adjusted according to the controlling load. In practice, interference should be avoided (temperature control). Therefore, a two-point control is preferred to proportional control. One can use internal reference voltage for simple applications. In that case, Pin 3 is inactive and connected to Pin 7 (GND), figure 9.





Firing Pulse Width t_p, (Figure 4)

This depends on the latching current of the triac and its load current. The firing pulse width is determined by the zero-crossing identification which can be influenced with the help of sync. resistance, R_{sync}, (figure 6).

$$t_p = \frac{2}{\omega} \operatorname{arc.sin}\left(\frac{I_L \times V_M}{P \sqrt{2}}\right)$$

where:

 \mathbf{I}_{L} = Latching current of the triac

$$V_{M}$$
 = Mains supply, effective

Ρ Power load (user's power) =

Total current consumption is influenced by the firing pulse width which can be calculated as follows:

$$R_{sync} = \frac{V_M \sqrt{2} \sin (\omega \times \frac{t_p}{2}) - 0.6 V}{3.5 \times 10^{-5} A} - 49 \text{ k}\Omega$$

Triac Firing Current (Pulse)

This depends on the triac requirement. It can be limited with gate series resistance which is calculated as follows:

$$R_{Gmax} \approx \frac{7.5 \text{ V} - V_{Gmax}}{I_{Gmax}} - 36 \Omega$$

$$I_P = \frac{I_{Gmax}}{T} \times t_p$$

whereby:

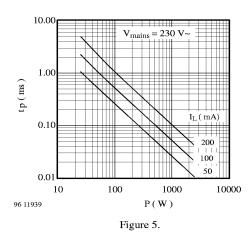
 V_{G} = Gate voltage

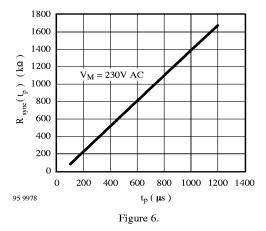
= Maximum gate current I_{Gmax}

= Average gate current Ip

t_p T = Firing pulse width

= Mains period duration





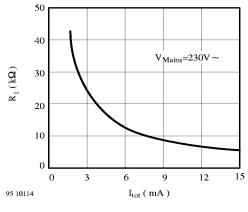
Supply Voltage

The integrated circuit U217B (which also contains internal voltage limiting) can be connected via the diode (D_1) and the resistor (R_1) with the mains supply. An internal climb circuit limits the voltage between Pin 5 and 7 to a typical value of 9.25 V.

The series resistance R_1 can be calculated (figures 7 and 8) as follows:

$$R_{1max} = 0.85 \frac{V_{min} - V_{Smax}}{2 I_{tot}}$$
; $P_{(R1)} = -\frac{(V_M - V_S)^2}{2 R_1}$

$$I_{tot} = I_S + I_P + I_x$$





whereby:

 I_S

 $\mathbf{I}_{\mathbf{X}}$

- V_M = Mains voltage V_S = Limiting voltage of the IC
- V_S = Limiting voltage of the IC I_{tot} = Total current consumption
 - = Current requirement of the IC (without load)
 - = Current requirement of other peripheral
 - components
- $P_{(R1)}$ = Power dissipation at R_1

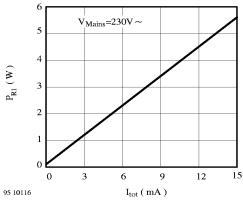


Figure 8.



Absolute Maximum Ratings

Reference point Pin 7

Parameters		Symbol	Value	Unit
Supply current	Pin 5	-I _S	30	mA
Sync. current	Pin 8	I _{Sync.}	5	mA
Output current ramp generator	Pin 1	Io	3	mA
Input voltages	Pin 1, 3, 4, 6 Pin 2 Pin 8	$\begin{array}{c c} -V_{I} \\ -V_{I} \\ \pm V_{I} \end{array}$	$\leq V_{\rm S}$ 2 to V_{\rm S} ≤ 7.3	V
Power dissipation $T_{amb} = 45^{\circ}C$ $T_{amb} = 100^{\circ}C$		P _{tot}	400 125	mW
Junction temperature		Ti	125	°C
Operating ambient temperature range	;	T _{amb}	0 to 100	°C
Storage temperature range		T _{stg}	-40 to $+ 125$	°C

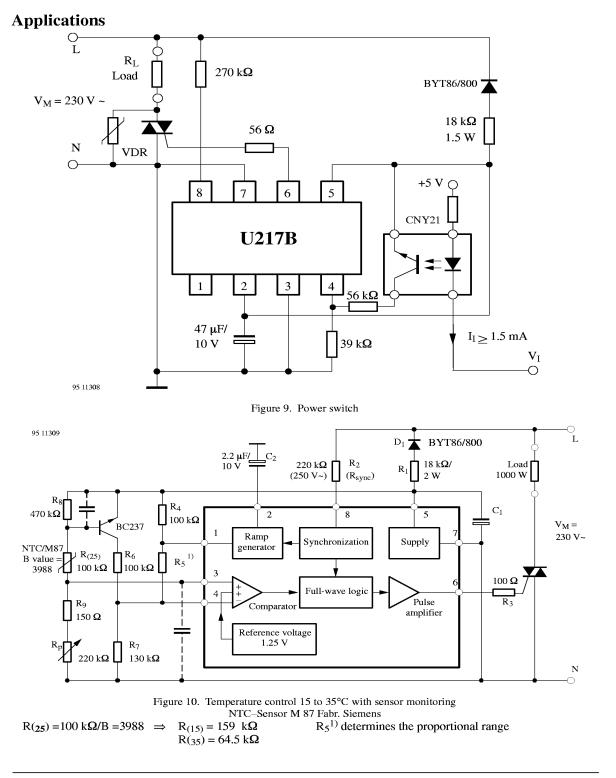
Thermal Resistance

Parameters	Symbol	Value	Unit
Junction ambient	R _{thJA}	200	K/W

Electrical Characteristics

 $-V_S = 8.5$ V, $T_{amb} = 25^{\circ}$ C, reference point Pin 7, unless otherwise specified

Parameters	Test Conditio	ons / Pin	Symbol	Min.	Тур.	Max.	Unit
Supply-voltage limitation	$-I_S = 5 \text{ mA}$	Pin 5	-V _S	8.6	9.25	9.9	V
Supply current		Pin 5	-I _S			500	μA
Voltage limitation	$I_8 = \pm 1 \text{ mA}$	Pin 8	$\pm V_{I}$	7.5		8.7	V
Synchronous current		Pin 8	±I _{sync}	0.12			mA
Zero detector			±I _{sync}		35		μA
Output pulse width	$V_{M} = 230 V \sim,$ $R_{sync} = 22$ $R_{sync} = 42$	20 k Ω 70 k Ω	tp		260 460		μs
Output pulse current	$V_6 = 0 V$	Pin 6	-I _O	100			mA
Comparator							
Input offset voltage		Pin 3,4	V _{I0}		5	15	mV
Input bias current		Pin 4	I _{IB}			1	μA
Common-mode input voltage		Pin 3,4	-V _{IC}	1		(V _S -1)	V
Threshold internal reference	$V_3 = 0 V$	Pin 4	$-V_{\mathrm{T}}$		1.25		V
Ramp generator, Pin 1, figu	ure 1						
Period	$ \begin{vmatrix} -I_{S} = 1 \text{ mA}, I_{sync} \\ C_{1} = 100 \ \mu\text{F}, C_{2} \\ R_{4} = 100 \ \textbf{k}\Omega \\ \end{vmatrix} $		Т		1.5		s
Final voltage			V ₁	0.9	1.40	1.80	V
Initial voltage]			6.8	7.3	7.8	
Charge current	$V_2 = 0 V, I_8 = -1$	mA Pin 2	-I ₂	13	17	26	μA



TEMIC

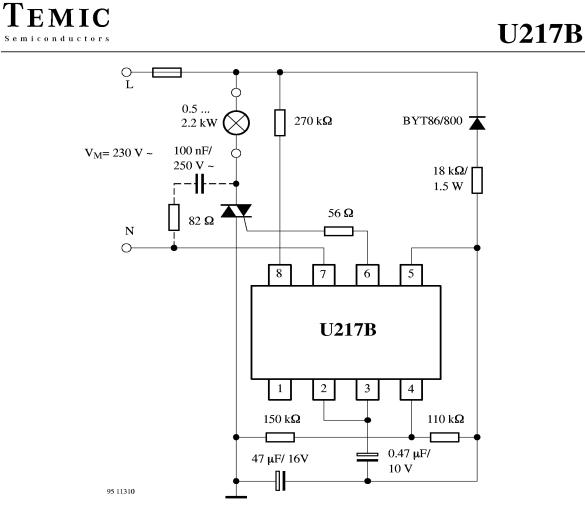


Figure 11. Power blinking switch with f \approx 2.7 Hz, duty cycle 1:1, power range 0.5 to 2.2 kW

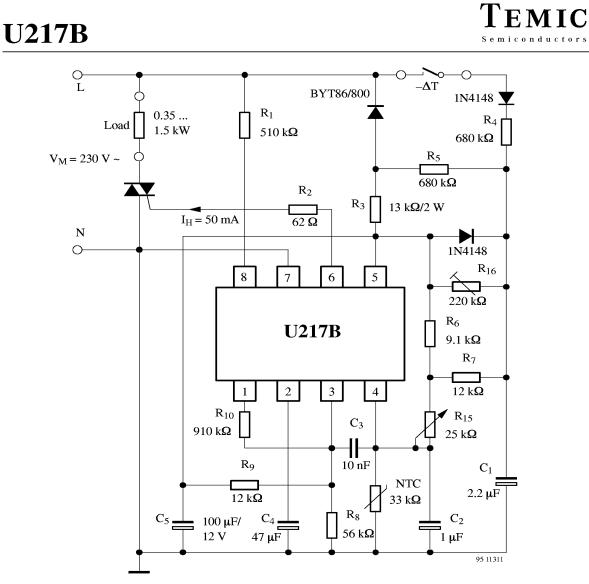


Figure 12. Room temperature control with definite reduction (remote control) for a temperature range of 5 to 30°C

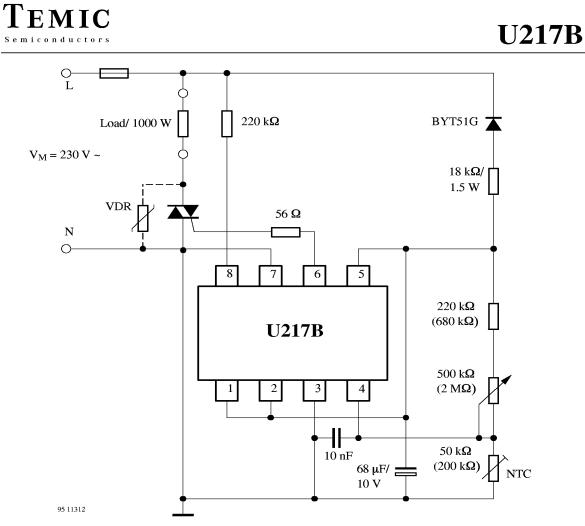


Figure 13. Two-point temperature control for a temperature range of 15 to 30°C

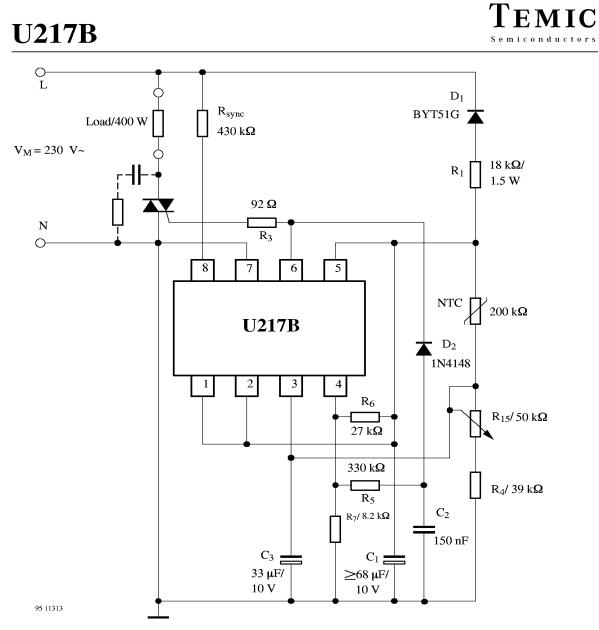
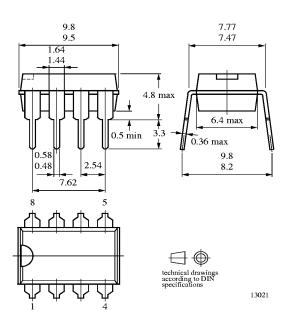


Figure 14. Two-point temperature control for a temperature range of 18 to 32° C and a hysteresis of $\pm 0.5^{\circ}$ C at 25° C

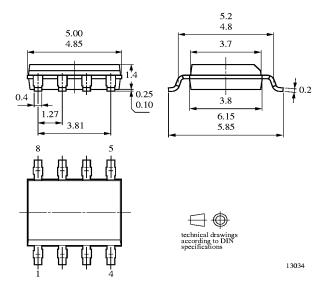


Package Information

Package DIP8 Dimensions in mm



Package SO8 Dimensions in mm



Ozone Depleting Substances Policy Statement

It is the policy of TEMIC TELEFUNKEN microelectronic GmbH to

- 1. Meet all present and future national and international statutory requirements.
- 2. Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

TEMIC TELEFUNKEN microelectronic GmbH semiconductor division has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

TEMIC can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice. Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use TEMIC products for any unintended or unauthorized application, the buyer shall indemnify TEMIC against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

TEMIC TELEFUNKEN microelectronic GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany Telephone: 49 (0)7131 67 2831, Fax number: 49 (0)7131 67 2423